

Pin Descriptions (Note 5)

Package: X1-DFN1216-4

Pin Number	Pin Name	Function
1	OUTPUT	Output Pin
2	V_{DD}	Power Supply Input
3	NC	No Connection (Note 5)
4	GND	Ground Pin

Package: X2-DFN2015-6

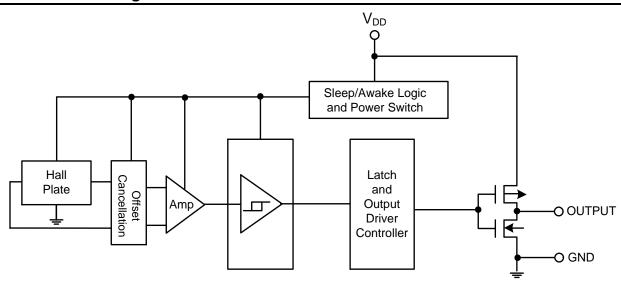
Pin Number	Pin Name	Function
1	V_{DD}	Power Supply Input
2	NC	No Connection (Note 5)
3	NC	No Connection (Note 5)
4	GND	Ground Pin
5	NC	No Connection (Note 5)
6	OUTPUT	Output Pin

Package: SOT553

Pin Number	Pin Name	Function
1	V_{DD}	Power Supply Input
2	NC	No Connection (Note 5)
3	NC	No Connection (Note 5)
4	GND	Ground Pin
5	OUTPUT	Output Pin

Note: 5. NC is "No Connection" pin and is not connected internally. This pin can be left open or tied to ground.

Functional Block Diagram





Absolute Maximum Ratings (Note 6) (@TA = +25°C, unless otherwise specified.)

Symbol	Para	Rating	Unit	
V_{DD}	Supply Voltage (Note 7)		6	V
V_{DD_REV}	Reverse Supply Voltage		-0.3	V
I _{OUTPUT}	Output Current (Source and Sink)	3	mA	
В	Magnetic Flux Density	Unlimited		
	Dockogo Dover Dissination	X1-DFN1216-4, X2-DFN2015-6	230	mW
P_{D}	P _D Package Power Dissipation SOT553		230	mW
Ts	Storage Temperature Range	-65 to +150	°C	
TJ	Maximum Junction Temperature	+150	°C	
ESD HBM	Human Body Model (HBM) ESD Capab	ility	8	kV

Notes:

- 6. Stresses greater than the 'Absolute Maximum Ratings' specified above can cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability can be affected by exposure to absolute maximum rating conditions for extended periods of time.
- 7. The absolute maximum V_{DD} of 6V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

Recommended Operating Conditions (@T_A = +25°C, unless otherwise specified.)

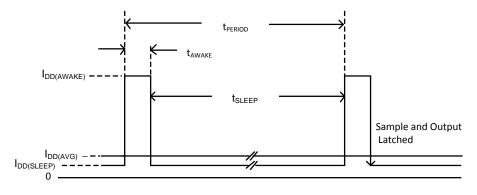
Symbol	Parameter	Conditions	Rating	Unit
V_{DD}	Supply Voltage	Operating	1.6V to 3.6V	٧
T _A	Operating Temperature Range	Operating	-40 to +85	°C

Electrical Characteristics (@ $T_A = +25^{\circ}C$, $V_{DD} = 1.85V$, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{OL}	Output Low Voltage (On)	I _{OUT} = 1mA	_	0.1	0.2	V
V _{OH}	Output High Voltage (Off)	$I_{OUT} = -1mA$	V _{DD} -0.2	V _{DD} -0.1	_	V
I _{OFF}	Output Leakage Current	$V_{OUT} = 3.6V$, Output off	_	< 0.1	1	μΑ
I _{DD(AWAKE)}	Supply Coursest	During 'awake' period, T _A = +25°C, V _{DD} = 3V	_	2.1	_	mA
I _{DD(SLEEP)}	Supply Current	During 'sleep' period, T _A = +25°C, V _{DD} = 3V	_	2.5	_	μΑ
	Average Supply Current	$T_A = +25^{\circ}C, V_{DD} = 1.85V$	_	4.3	8	μΑ
I _{DD(AVG)}	Average Supply Current	$T_A = +25^{\circ}C, V_{DD} = 3.6V$	_	7.2	13	μΑ
tawake	Awake Time	(Note 8)	_	50	100	μs
t _{PERIOD}	Period	(Note 8)	_	50	100	ms
D.C.	Duty Cycle	_	_	0.1	_	%

Note:

When power is initially turned on, the operating V_{DD} (1.6V to 3.6V) must be applied to guaranteed the output sampling.
The output state is valid after the second operating cycle (typical 100ms).



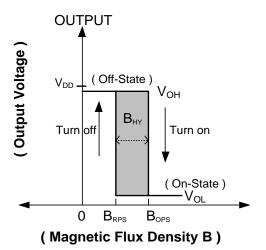


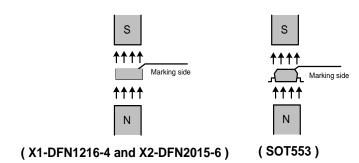
$\textbf{Magnetic Characteristics} \text{ (Notes 9 and 10) } (@T_A = +25^{\circ}\text{C}, V_{DD} = 1.85\text{V}, \text{ unless otherwise specified.)}$

					(1mT=10 (Gauss)
Symbol	Characteristics	Test Condition	Min	Тур	Max	Unit
D. (Couth Dale to Dort Marking Cide)	Operation Point	$T_A = +25$ °C	16	30	42	
B _{OPS} (South Pole to Part Marking Side)	Operation Point	$T_A = -40$ °C to $+85$ °C	14	30	46	
D. (Cavith Dala to Dant Manking Cida)	Release Point	$T_A = +25$ °C	11	20	35	Gauss
B _{RPS} (South Pole to Part Marking Side)		$T_A = -40$ °C to $+85$ °C	9	20	39	
D. (IDenvil IDenvil)	Liveteresia (Nieta 11)	$T_A = +25$ °C	5	10	15	
B _{HY} (Bopx - Brpx)	Hysteresis (Note 11)	$T_A = -40$ °C to $+85$ °C	3	10	17	

Notes:

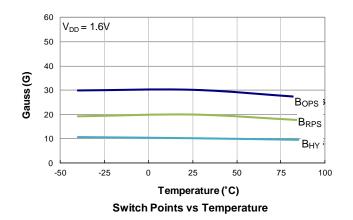
- 9. Typical data is at $T_A = +25$ °C, $V_{DD} = 1.85$ V.
- Maximum and minimum parameters values over operating temperature range are not tested in production, they are guaranteed by design, process control and characterization. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.
- 11. Maximum and minimum hysteresis is guaranteed by design and characterization.

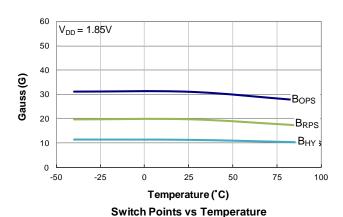


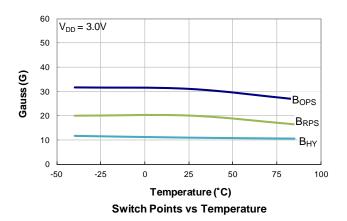


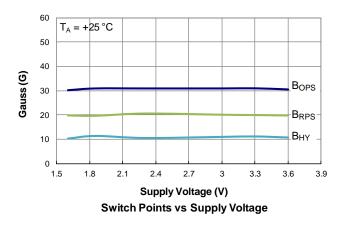


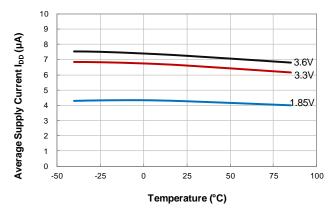
Typical Operating Characteristics

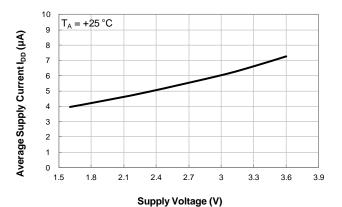










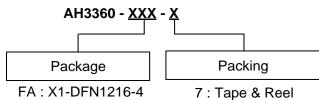


Average Supply Current vs. Temperature

Average Supply Current vs. Supply Voltage



Ordering Information



FT4: X2-DFN2015-6

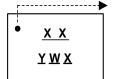
Z: SOT553

Part Number	Backago Codo	Packaging	7" Tape and Reel		
Fait Number	Package Code	Packaging	Quantity	Part Number Suffix	
AH3360-FA-7	FA	X1-DFN1216-4	3000/Tape & Reel	-7	
AH3360-FT4-7	FT4	X2-DFN2015-6	3000/Tape & Reel	-7	
AH3360-Z-7	Z	SOT553	3000/Tape & Reel	-7	

Marking Information

(1) Package Types: X1-DFN1216-4 and X2-DFN2015-6





Pin 1 Indicator

XX: Identification Code

<u>Y</u> : Year : 0~9

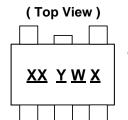
 \underline{W} : Week: A~Z: 1~26 week;

a~z: 27~52 week; z represents

52 and 53 week \underline{X} : A~Z: Green

Part Number	Package	Identification Code
AH3360-FA-7	X1-DFN1216-4	KZ
AH3360-FT4-7	X2-DFN2015-6	NZ

(2) Package Type: SOT553



 $\frac{XX}{Y}: \mbox{Identification Code} \\ \underline{Y}: \mbox{Year}: 0 \mbox{ to } 9$

W: Week: A to Z: 1~26 week; a to z: 27~52 week; z represents 52 and 53 week

X: Internal code

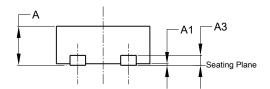
Part Number	Package	Identification Code
AH3360-Z-7	SOT553	KZ

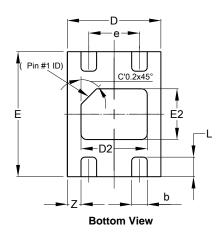


Package Outline Dimensions (All dimensions in mm.)

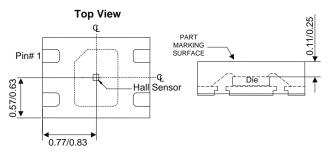
Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: X1-DFN1216-4





	X1-DFN1216-4						
Dim	Min	Max	Тур				
Α	0.47	0.53	0.50				
A1	0.00	0.05	0.02				
A3	-	-	0.13				
b	0.15	0.25	0.20				
D	1.15	1.25	1.20				
D2	0.75	0.95	0.85				
Е	1.55	1.65	1.60				
E2	0.55	0.75	0.65				
е	-	-	0.65				
L	0.20	0.30	0.25				
Z	-	-	0.175				
All C	imens	ions in	mm				



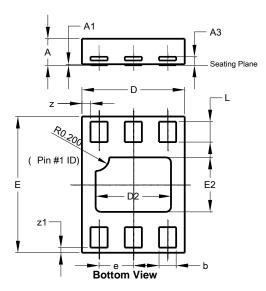
Sensor Location



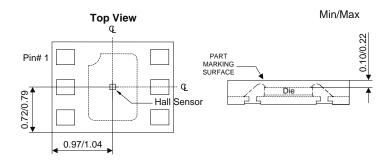
Package Outline Dimensions (continued) (All dimensions in mm.)

Please see http://www.diodes.com/package-outlines.html for the latest version.

(2) Package Type: X2-DFN2015-6



)	X2-DFN2015-6							
Dim	Min	Max	Тур					
Α	0.375	0.40	0.390					
A1	0	0.05	0.02					
А3	-	-	0.13					
b	0.20	0.30	0.25					
D	1.45	1.575	1.50					
D2	1.00	1.20	1.10					
е	-	1	0.50					
E	1.95	2.075	2.00					
E2	0.70	0.90	0.80					
L	0.25	0.35	0.30					
Z	-	-	0.125					
Z1	-	-	0.075					
All D	All Dimensions in mm							



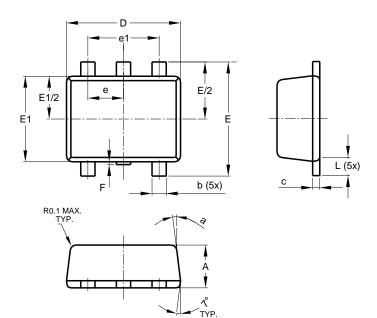
Sensor Location



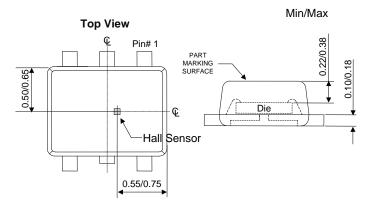
Package Outline Dimensions (continued) (All dimensions in mm.)

Please see http://www.diodes.com/package-outlines.html for the latest version.

(3) Package Type: SOT553



SOT553				
Dim	Min	Max	Тур	
Α	0.55	0.62	0.60	
b	0.15	0.30	0.20	
C	0.10	0.18	0.15	
D	1.50	1.70	1.60	
Е	1.55	1.70	1.60	
E1	1.10	1.25	1.20	
е	0.50 BSC			
e1	1.00 BSC			
F	0.00	0.10	_	
L	0.10	0.30	0.20	
а	6°	8°	7°	
All Dimensions in mm				



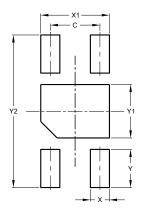
Sensor Location



Suggested Pad Layout

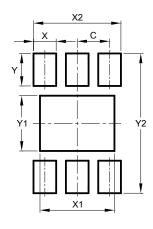
Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: X1-DFN1216-4



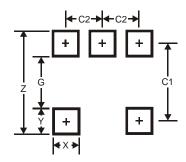
X1-DFN1216-4		
Dimensions	Value	
С	0.65	
Х	0.25	
X1	0.90	
Υ	0.50	
Y1	0.70	
Y2	2.00	
All Dimensions in mm		

(2) Package Type: X2-DFN2015-6



X2-DFN2015-6		
Dimensions	Value	
С	0.500	
Х	0.350	
X1	1.150	
X2	1.350	
Y	0.500	
Y1	0.850	
Y2	2.150	
All Dimensions in mm		

(3) Package Type: SOT553



SOT553		
Dimensions	Value	
Z	2.2	
G	1.2	
X	0.375	
Υ	0.5	
C1	1.7	
C2	0.5	
All Dimensions in mm		



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